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In re

Appl. No.: 10/016,113
Amdt. Dated: November 14, 2003
Reply to Office Action of: October 16, 2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

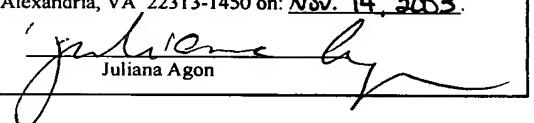
Appl. No. : 10/016,113
Applicant : Robert A. Bourdreau, et al
Filed : November 2, 2001
Title : Silicon Waferboard

TC/A.U. : 2874
Examiner : Juliana K. Kang
Docket No. : SP01-319

Mail Stop: Non-Fee Amendments
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING (37 CFR 1.8a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Mail Stop: Non-Fee Amendments, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on: Nov. 14, 2003.



Juliana Agon

AMENDMENT

Sir:

In response to the Office action of October 16, 2003, paper number 0903, please amend the above-identified as follows:

Amendments to the claims begin on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.